



150V N-CHANNEL ENHANCEMENT MODE MOSFET PowerDI5060-8

Product Summary

BV _{DSS}	R _{DS(ON)} Max	I _D Max T _C = +25°C
450)/	17.5mΩ @ V _{GS} = 10V	58A
150V	25.5mΩ @ V _{GS} = 4.5V	48A

Description

This new generation N-Channel Enhancement Mode MOSFET is designed to minimize $R_{DS(ON)}$, yet maintain superior switching performance. This device is ideal for use in notebook battery power management and load switch.

Applications

- Synchronous Rectification
- Power Switching
- Class D Audio Amplifier

Features

- 100% Unclamped Inductive Switching (UIS) Test in Production Ensures More Reliable and Robust End Application
- Thermally Efficient Package-Cooler Running Applications
- High Conversion Efficiency
- Low R_{DS(ON)} Minimizes On-State Losses
- Low Input Capacitance
- Fast Switching Speed
- <1.1mm Package Profile Ideal for Thin Applications (PowerDI®)</p>
- Lead-Free Finish; RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- For automotive applications requiring specific change control (i.e. parts qualified to AEC-Q101, PPAP capable, and manufactured in IATF 16949 certified facilities), please contact us or your local Diodes representative.
- https://www.diodes.com/quality/product-definitions/

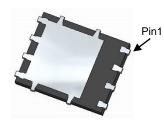
Mechanical Data

- Case: PowerDI5060-8
- Case Material: Molded Plastic, "Green" Molding Compound.
 UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections: See Diagram Below
- Terminal Finish Matte Tin Annealed over Copper Leadframe.
 Solderable per MIL-STD-202, Method 208
- Weight: 0.097 grams (Approximate)

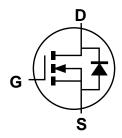
PowerDI5060-8



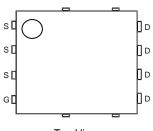




Bottom View



Internal Schematic



Top View Pin Configuration

Ordering Information (Note 4)

Part Number	Case	Packaging
DMT15H017LPS-13	PowerDI5060-8	2,500 / Tape & Reel

Notes:

- 1. EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant. All applicable RoHS exemptions applied.
- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.



Marking Information



T1517LPS = Product Type Marking
T1517LPS = Product Type Marking Code
YYWW = Date Code Marking
YY = Last Two Digits of Year (ex: 19 = 2019)
WW = Week Code (01 to 53)

Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit		
Drain-Source Voltage	V _{DSS}	150	V		
Gate-Source Voltage			V _{GSS}	±20	V
Continuous Durin Comment / 401/ (Note C)	Steady	T _A = +25°C		9.4	А
Continuous Drain Current V _{GS} = 10V (Note 6)	State	T _A = +70°C	I _D	7.5	
Continuous Dusin Comment / 401/ (Nate 7)	Steady	T _C = +25°C		58	А
Continuous Drain Current V _{GS} = 10V (Note 7)	State	T _C = +70°C	l _D	46	
Pulsed Drain Current (10µs Pulse, Duty Cycle = 1%)	I _{DM}	230	Α		
Maximum Continuous Body Diode Forward Current	Is	74	Α		
Pulsed Body Diode Current (10µs Pulse, Duty Cycle = 1%)	I _{SM}	230	Α		
Avalanche Current (Note 8), L = 3mH			I _{AS}	14.5	Α
Avalanche Energy (Note 8), L = 3mH			E _{AS}	315.4	mJ

Thermal Characteristics

Characteristic		Symbol	Value	Unit
Total Power Dissipation (Note 5)	$T_A = +25^{\circ}C$	P_{D}	1.3	W
Thermal Resistance, Junction to Ambient (Note 5)	Steady State	$R_{ heta JA}$	99	°C/W
Total Power Dissipation (Note 6)	$T_A = +25^{\circ}C$	P_{D}	2.3	W
Thermal Resistance, Junction to Ambient (Note 6)	Steady State	$R_{ heta JA}$	53	°C/W
Total Power Dissipation (Note 7)	T _C = +25°C	P _D	89	W
Thermal Resistance, Junction to Case (Note 7)		$R_{ heta JC}$	1.4	°C/W
Operating and Storage Temperature Range		$T_{J_1}T_{STG}$	-55 to +150	°C

Notes:

- 5. Device mounted on FR-4 PC board, with minimum recommended pad layout, single sided.
- 6. Device mounted on FR-4 substrate PC board, 2oz copper, with thermal bias to bottom layer 1inch square copper plate.
- 7. Thermal resistance from junction to soldering point (on the exposed drain pad).
- 8. I_{AS} and E_{AS} ratings are based on low frequency and duty cycles to keep T_J = +25°C.



Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

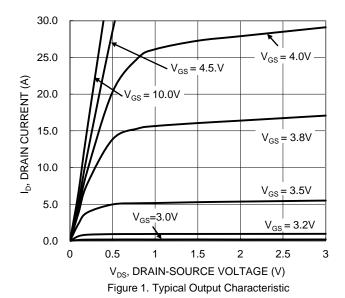
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 9)							
Drain-Source Breakdown Voltage	BV _{DSS}	150	_	_	V	$V_{GS} = 0V, I_{D} = 10mA$	
Zero Gate Voltage Drain Current	I _{DSS}	_	_	1	μΑ	V _{DS} = 120V, V _{GS} = 0V	
Gate-Source Leakage	I _{GSS}	_	_	±100	nA	$V_{GS} = \pm 20V, V_{DS} = 0V$	
ON CHARACTERISTICS (Note 9)							
Gate Threshold Voltage	V _{GS(TH)}	1.3	_	2.6	V	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	
Static Drain-Source On-Resistance		_	14	17.5	mΩ	$V_{GS} = 10V, I_D = 20A$	
Static Drain-Source On-Resistance	R _{DS(ON)}	_	18	25.5	11177	$V_{GS} = 4.5V, I_D = 20A$	
Diode Forward Voltage	V_{SD}	_	0.8	1.2	V	$V_{GS} = 0V, I_{S} = 20A$	
DYNAMIC CHARACTERISTICS (Note 10)			•	•			
Input Capacitance	C _{iss}	_	3369	_		V _{DS} = 75V, V _{GS} = 0V f = 1MHz	
Output Capacitance	Coss	_	211	_	pF		
Reverse Transfer Capacitance	Crss	_	6.7	_			
Gate Resistance	Rg	_	1.9	_	Ω	$V_{DS} = 0V$, $V_{GS} = 0V$, $f = 1MHz$	
Total Gate Charge	Qq	_	50	_		751/ 1 004	
Gate-Source Charge	Q _{qs}	_	12.8	_	nC	$V_{DD} = 75V, I_D = 20A,$ $V_{GS} = 10V$	
Gate-Drain Charge	Q_{gd}	_	9.4	_		VGS = 10V	
Turn-On Delay Time	t _{D(ON)}	_	10.5	_			
Turn-On Rise Time	t _R	_	16.3	_		$V_{DD} = 75V, V_{GS} = 10V,$ $I_{D} = 20A, R_{q} = 6\Omega$	
Turn-Off Delay Time	t _{D(OFF)}		44.6	_	ns		
Turn-Off Fall Time	t _F		17.7	_			
Reverse Recovery Time	t _{RR}		72	_	ns	1 00A 11/44 400A/	
Reverse Recovery Charge	Q _{RR}	_	215	_	nC	I _F = 20A, di/dt = 100A/μs	

Notes:

^{9.} Short duration pulse test used to minimize self-heating effect.10. Guaranteed by design. Not subject to product testing.







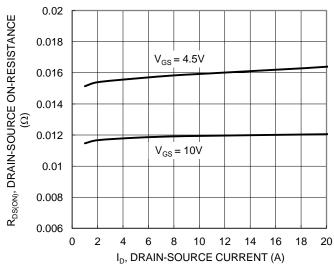


Figure 3. Typical On-Resistance vs. Drain Current and Gate Voltage

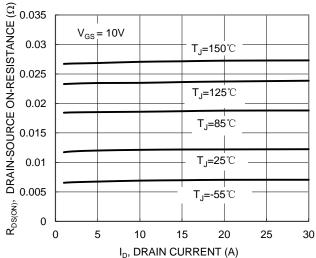


Figure 5. Typical On-Resistance vs. Drain Current and Junction Temperature

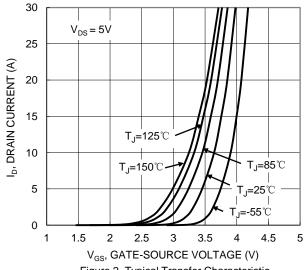


Figure 2. Typical Transfer Characteristic

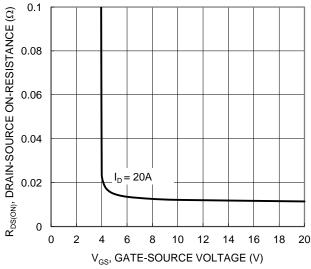


Figure 4. Typical Transfer Characteristic

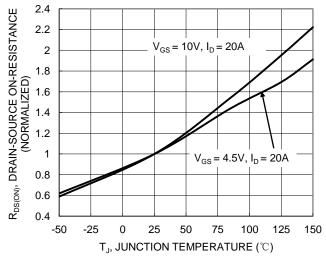


Figure 6. On-Resistance Variation with Junction Temperature



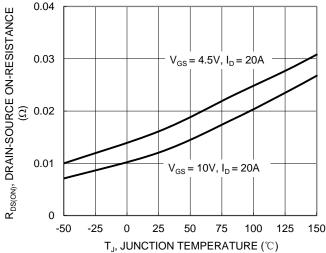
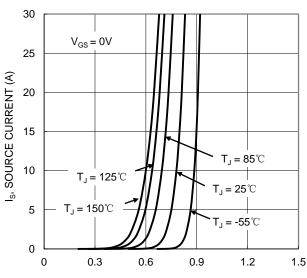
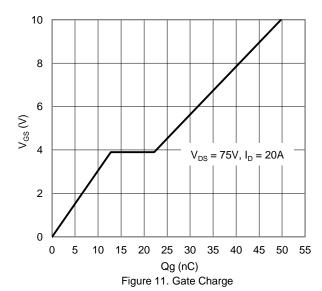


Figure 7. On-Resistance Variation with Junction Temperature



V_{SD}, SOURCE-DRAIN VOLTAGE (V) Figure 9. Diode Forward Voltage vs. Current



3 2.8 9V 2.6 0Λ 2.4 1_D = 1mA 1_D = 250μA 1_D = 250μA 1_D = 250μA

25

-50

-25

 T_J , JUNCTION TEMPERATURE ($^{\circ}$ C) Figure 8. Gate Threshold Variation vs. Junction Temperature

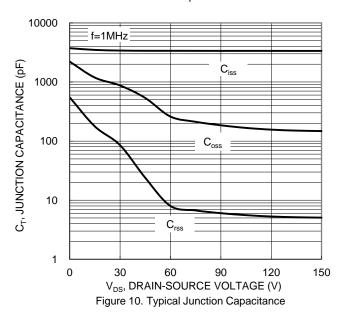
50

75

100

125

150



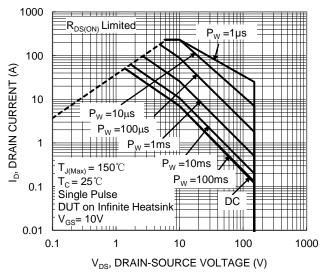


Figure 12. SOA, Safe Operation Area



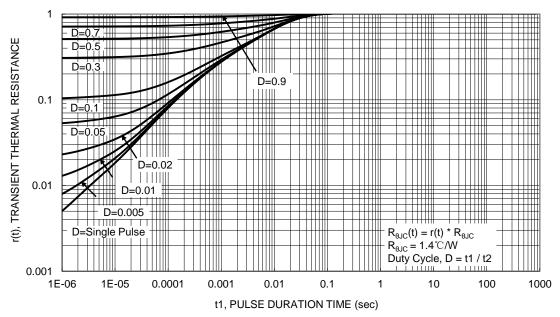


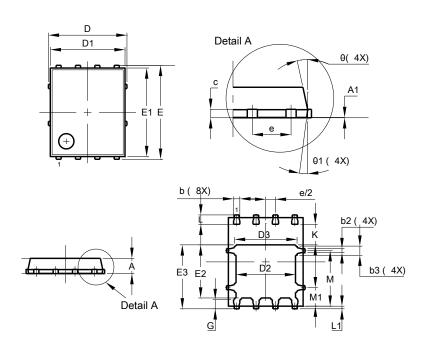
Figure 13. Transient Thermal Resistance



Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

PowerDI5060-8

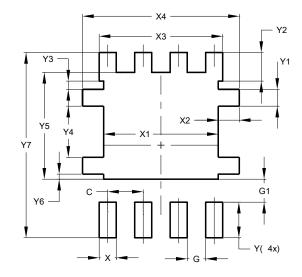


PowerDI5060-8					
Dim	Min	Max	Тур		
Α	0.90	1.10	1.00		
A1	0.00	0.05	-		
b	0.33	0.51	0.41		
b2	0.200	0.350	0.273		
b3	0.40	0.80	0.60		
С	0.230	0.330	0.277		
D	,	5.15 BSC	;		
D1	4.70	5.10	4.90		
D2	3.70	4.10	3.90		
D3	3.90 4.30 4.10				
E	(6.15 BSC	;		
E1	5.60	6.00	5.80		
E2	3.28	3.68	3.48		
E3	3.99	4.39	4.19		
е	1.27 BSC				
G	0.51	0.71	0.61		
K	0.51	_	-		
L	0.51	0.71	0.61		
L1	0.100	0.200	0.175		
M	3.235	4.035	3.635		
M1	1.00	1.40	1.21		
Θ	10°	12°	11°		
Θ1	6°	8°	7°		
All Dimensions in mm					

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

PowerDI5060-8



Dimensions	Value (in mm)			
С	1.270			
G	0.660			
G1	0.820			
X	0.610			
X1	4.100			
X2	0.755			
Х3	4.420			
X4	5.610			
Υ	1.270			
Y1	0.600			
Y2	1.020			
Y3	0.295			
Y4	1.825			
Y5	3.810			
Y6	0.180			
Y7	6.610			



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